# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3341248

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the PROPERTY NUMBERS SECTION. CORRECTIVE ASSIGNMENT NOW CONTAINS OMITTED PCT/CN2013/073765, PCT/CN2012/073526 AND PCT/CN2012/080622 previously recorded on Reel 034364 Frame 0761. Assignor(s) hereby confirms the PCT/CN2013/073765, PCT/CN2012/073526, PCT/CN2012/080622 SHOULD HAVE BEEN ON ASSIGNMENT. ASSIGNORS ASSIGN RIGHTS TO ASSIGNEE

#### **CONVEYING PARTY DATA**

Name	Execution Date
MASAKAZU SHIROTA	03/20/2015
XIPENG ZHU	04/28/2015
ARVIND SWAMINATHAN	03/18/2015
JUN WANG	03/18/2015
GEORGE CHERIAN	03/07/2015

# **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

#### **PROPERTY NUMBERS Total: 3**

Property Type	Number
Application Number:	14387836
PCT Number:	CN2012073526
PCT Number:	CN2012080622

#### **CORRESPONDENCE DATA**

503294630

**Fax Number:** (202)857-6395

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 202-857-6000

Email: dcipdocket@arentfox.com

**Correspondent Name:** ARENT FOX, LLP **Address Line 1:** 1717 K STREET, NW

Address Line 4: WASHINGTON, D.C. 20006-5344

NAME OF SUBMITTER:	REBECCA GOLDEN
SIGNATURE:	/Rebecca Golden/
DATE SIGNED:	05/06/2015

#### **Total Attachments: 26**

source=121978 SupportingDocumentsForCorrection#page1.tif source=121978 SupportingDocumentsForCorrection#page2.tif source=121978 SupportingDocumentsForCorrection#page3.tif source=121978\_SupportingDocumentsForCorrection#page4.tif source=121978 SupportingDocumentsForCorrection#page5.tif source=121978 SupportingDocumentsForCorrection#page6.tif source=121978\_SupportingDocumentsForCorrection#page7.tif source=121978\_SupportingDocumentsForCorrection#page8.tif source=121978 SupportingDocumentsForCorrection#page9.tif source=121978 SupportingDocumentsForCorrection#page10.tif source=121978\_SupportingDocumentsForCorrection#page11.tif source=121978 SupportingDocumentsForCorrection#page12.tif source=121978 SupportingDocumentsForCorrection#page13.tif source=121978 SupportingDocumentsForCorrection#page14.tif source=121978 SupportingDocumentsForCorrection#page15.tif source=121978 SupportingDocumentsForCorrection#page16.tif source=121978 SupportingDocumentsForCorrection#page17.tif source=121978\_SupportingDocumentsForCorrection#page18.tif source=121978 SupportingDocumentsForCorrection#page19.tif source=121978 SupportingDocumentsForCorrection#page20.tif source=121978 SupportingDocumentsForCorrection#page21.tif source=121978 SupportingDocumentsForCorrection#page22.tif source=121978 SupportingDocumentsForCorrection#page23.tif source=121978 SupportingDocumentsForCorrection#page24.tif source=121978\_SupportingDocumentsForCorrection#page25.tif source=121978 SupportingDocumentsForCorrection#page26.tif

#### WHEREAS, WE,

- 1. Masakazu SHIROTA, a citizen of Japan, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Yokohama-shi, Japan;
- 2. **Xipeng ZHU**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of **Beijing**, **China**;
- 3. Arvind SWAMINATHAN, a citizen of India, having a mailing address located at 3184 Vinifera Dr., San Jose, CA 95135, and a resident San Jose, California;
- 4. Jun WANG, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Poway, California; and
- 5. George CHERIAN, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHOD AND APPARATUS FOR LTE RADIO ACCESS NETWORK SHARING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS under the Patent Cooperation Treaty (PCT), and/or in the United States, including but not limited to U.S. Application No(s). 14/387,836 filed April 4, 2013, Qualcomm Reference No. 121978, International Patent Application No(s). PCT/CN2013/073765 filed April 4, 2013, Qualcomm Reference No. 121978WO2, and all provisional applications relating thereto, together with International Application No(s).

PCT/CN2012/073526, filed April 5, 2012, Qualcomm Reference No. 121978WO1, and PCT/CN2012/080622, filed August 27, 2012, Qualcomm Reference No. 123910WO1 (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all non-provisional applications, national phase applications, divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof:

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

# PATENT QUALCOMM Ref. No. 121978 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing nor do any act whatsoever conflicting with these presents.

Done at Tok	<u>70</u> , on <u>1</u>	lar 20 , 2015	Masakazu SHIROTA
LOCA	MON	DATE	Masakazu SHIROTA
eco o o			
Done at	, on	river	Xipeng ZHU
LUCA	13000	DAIL	Aspeag ZnO
Done atLOCA			
LOCA	TION	DATE	Arvind SWAMINATHAN
Done at	, on		
LOCA.		DATE	Jun WANG
Done at			
	TION		George CHERIAN

#### WHEREAS, WE,

- 1. Masakazu SHIROTA, a citizen of Japan, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Yokohama-shi, Japan;
- 2. **Xipeng ZHU**, a citizen of **China**, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of **Beijing**, **China**;
- 3. Arvind SWAMINATHAN, a citizen of India, having a mailing address located at 3184 Vinifera Dr., San Jose, CA 95135, and a resident San Jose, California;
- 4. Jun WANG, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Poway, California; and
- 5. George CHERIAN, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHOD AND APPARATUS FOR LTE RADIO ACCESS NETWORK SHARING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS under the Patent Cooperation Treaty (PCT), and/or in the United States, including but not limited to U.S. Application No(s). 14/387,836 filed April 4, 2013, Qualcomm Reference No. 121978, International Patent Application No(s). PCT/CN2013/073765 filed April 4, 2013, Qualcomm Reference No. 121978WO2, and all provisional applications relating thereto, together with International Application No(s).

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AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

# **PATENT**

QUALCOMM Ref. No. 121978 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing nor do any act whatsoever conflicting with these presents.

Done at		, on	
		, on DATE	Masakazu SHIROTA
Done at	Belling	, on <u>April 28, 2004</u>	Vinena ZHII
	LOCATION	DATE	Xipeng ZHU
Done at		, on	
	LOCATION	DATE	Arvind SWAMINATHAN
Done at		, on	
	LOCATION	DATE	Jun WANG
Done at	•	, on	
W. M. SYR. BYR.	LOCATION	DATE	George CHERIAN

# WHEREAS, WE,

- 1. Masakazu SHIROTA, a citizen of Japan, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Yokohama-shi, Japan;
- 2. Xipeng ZHU, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Beijing, China;
- 3. Arvind SWAMINATHAN, a citizen of India, having a mailing address located at 3184 Vinifera Dr., San Jose, CA 95135, and a resident San Jose, California;
- 4. Jun WANG, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Poway, California; and
- 5. George CHERIAN, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHOD AND APPARATUS FOR LTE RADIO ACCESS NETWORK SHARING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS under the Patent Cooperation Treaty (PCT), and/or in the United States, including but not limited to U.S. Application No(s). 14/387.836 filed April 4, 2013, Qualcomm Reference No. 121978, International Patent Application No(s). PCT/CN2013/073765 filed April 4, 2013, Qualcomm Reference No. 121978WO2, and all provisional applications relating thereto, together with International Application No(s).

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Done at		, on		
	LOCATION		DATE	Masakazu SHIROTA
Done at		, on		
	LOCATION		DATE	Xipeng ZHU
Done at	SAN JOSE LOCATION	_, on <u>3</u>	Jig/2015 DATE	Arvind SWAMINATHAN
Done at				
	LOCATION		DATE	Jun WANG
Done at	-	_, on		
	LOCATION		DATE	George CHERIAN

#### WHEREAS, WE,

- 1. Masakazu SHIROTA, a citizen of Japan, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Yokohama-shi, Japan:
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- 5. George CHERIAN, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHOD AND APPARATUS FOR LTE RADIO ACCESS NETWORK SHARING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

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AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

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Done at	, on		
	LOCATION	DATE	Masakazu SHIROTA
Done at	, on		
	LOCATION	DATE	Xipeng ZHU
Done at	, on		
	LOCATION	DATE	Arvind SWAMINATHAN
Done at	San Diago, on_ LOCATION	3/18/201	(2-5)
•	LOCATION	DATE	Jun WANG
Done at	, on		
	LOCATION	DATE	George CHERIAN

## WHEREAS, WE,

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AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

Done at	, QI	n.		
	LOCATION	DATE	Masakazu SHIROTA	^^*************************************
Done at	, oi	n	·	
	LOCATION	DATE	Xipeng ZHU	
Done at	. 01	n		
	LOCATION	DATE	Arvind SWAMINATHAN	
Done at	, 01	n		
	LOCATION	DATE	Jun WANG	
Done at	San Diey, or	46/15		
	LOCATION	DATE	George CHERIAN	***************************************



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# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
MASAKAZU SHIROTA	11/06/2014
XIPENG ZHU	11/04/2014
ARVIND SWAMINATHAN	11/18/2014
JUN WANG	11/07/2014
GEORGE CHERIAN	11/17/2014

#### **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED			
Street Address:	5775 MOREHOUSE DRIVE			
City:	SAN DIEGO			
State/Country:	CALIFORNIA			
Postal Code:	92121-1714			

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14387836

# **CORRESPONDENCE DATA**

Fax Number:

Phone: 213-629-7400

Email: dcipdocket@arentfox.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number,

if provided; if that is unsuccessful, it will be sent via US Mail.

Correspondent Name: ARENT FOX LLP AND QUALCOMM INCORPORATED

Address Line 1: 1717 K STREET, NW

Address Line 4: WASHINGTON, D.C. 20006-5344

ATTORNEY DOCKET

NUMBER:

Signature:

030284.08908 / 121978

NAME OF SUBMITTER: PEGGY O'CONNOR

/Peggy O'Connor/

Date: 12/03/2014

#### **Total Attachments: 7**

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DECEMBER 4, 2014

PTAS

ARENT FOX LLP AND QUALCOMM INCORPORATED 1717 K STREET, NW WASHINGTON, DC 20006-5344

503085079

UNITED STATES PATENT AND TRADEMARK OFFICE NOTICE OF RECORDATION OF ASSIGNMENT DOCUMENT

THE ENCLOSED DOCUMENT HAS BEEN RECORDED BY THE ASSIGNMENT RECORDATION BRANCH OF THE U.S. PATENT AND TRADEMARK OFFICE. A COMPLETE COPY IS AVAILABLE AT THE ASSIGNMENT SEARCH ROOM ON THE REEL AND FRAME NUMBER REFERENCED BELOW.

PLEASE REVIEW ALL INFORMATION CONTAINED ON THIS NOTICE. THE INFORMATION CONTAINED ON THIS RECORDATION NOTICE REFLECTS THE DATA PRESENT IN THE PATENT AND TRADEMARK ASSIGNMENT SYSTEM. IF YOU SHOULD FIND ANY ERRORS OR HAVE QUESTIONS CONCERNING THIS NOTICE, YOU MAY CONTACT THE ASSIGNMENT RECORDATION BRANCH AT 571-272-3350. PLEASE SEND REQUEST FOR CORRECTION TO: U.S. PATENT AND TRADEMARK OFFICE, MAIL STOP: ASSIGNMENT RECORDATION BRANCH, P.O. BOX 1450, ALEXANDRIA, VA 22313.

RECORDATION DATE: 12/03/2014 REEL/FRAME: 034364/0761

NUMBER OF PAGES: 9

BRIEF: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).

DOCKET NUMBER: 030284.08908 / 121978

ASSIGNOR:

SHIROTA, MASAKAZU DOC DATE: 11/06/2014

ASSIGNOR:

ZHU, XIPENG DOC DATE: 11/04/2014

ASSIGNOR:

SWAMINATHAN, ARVIND DOC DATE: 11/18/2014

ASSIGNOR:

WANG, JUN DOC DATE: 11/07/2014

ASSIGNOR:

DOC DATE: 11/17/2014 CHERIAN, GEORGE

ASSIGNEE:

QUALCOMM INCORPORATED 5775 MOREHOUSE DRIVE SAN DIEGO, CALIFORNIA 92121-1714

> **PATENT** P.O. Box 1450, Alexandria, Virginia 22313-1450 - WWW.USPTO.GOV

REEL: 035602 FRAME: 0972

APPLICATION NUMBER: 14387836 FILING DATE: 09/24/2014

PATENT NUMBER: ISSUE DATE:

TITLE: METHOD AND APPARATUS FOR LTE RADIO ACCESS NETWORK SHARING

ASSIGNMENT RECORDATION BRANCH

PUBLIC RECORDS DIVISION

#### WHEREAS, WE,

- 1. Masakazu SHIROTA, a citizen of Japan, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Yokohama-shi, Japan:
- 2. Xipeng ZHU, a citizen of China, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Beijing, China;
- 3. Arvind SWAMINATHAN, a citizen of India, having a mailing address located at 3184 Vinifera Dr., San Jose, CA 95135, and a resident San Jose, California;
- 4. Jun WANG, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of Poway, California; and
- 5. George CHERIAN, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714, and a resident of San Diego, California.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHOD AND APPARATUS FOR LTE RADIO ACCESS NETWORK SHARING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/387,836 filed April 4, 2013, Qualcomm Reference No. 121978, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-

QUALCOMM Ref. No. 121978

Page 2 of 3

part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

Done at	Tokyo	_, on _	Nov 6	2014	Masakazu SHIROTA
	LOCATION		DATE		Masakazu SHIROTA
Done at		, on			
	LOCATION		DATE		Xipeng ZHU
Done at		on			
Done at	LOCATION	, 011 _	DATE		Arvind SWAMINATHAN
_					
Done at	LOCATION				Jun WANG
Done at _		_, on _			
	LOCATION		DATE		George CHERIAN

Done at		_, on _		
	LOCATION		DATE	Masakazu SHIROTA
Done at	Beijing	, on _	Nov 4, 2011	Xipeng ZHU W (Xipeng)
Done at	LOCATION	_, on _	DATE	Arvind SWAMINATHAN
Done at	LOCATION	_, on _	DATE	Jun WANG
Done at	LOCATION		DATE	George CHERIAN

Done at		, on	
	LOCATION	DATE	Masakazu SHIROTA
Done at	LOCATION	on	Xipeng ZHU
Done at	SAN JOSE, LOCATION		No. 148
Done at	LOCATION	, on	Jun WANG
Done at	LOCATION ,	, on	George CHERIAN

Done at		, on	***************************************	
	LOCATION		DATE	Masakazu SHIROTA
Done at	LOCATION	_, on	DATE	Xipeng ZHU
Done at	LOCATION	_, on	DATE	Arvind SWAMINATHAN
Done at	San Diego LOCATION	, on	/////Ji/K DATE	Jun WANG
Done at	LOCATION		DATE	George CHERIAN

# PATENT

QUALCOMM Ref. No. 121978 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing nor do any act whatsoever conflicting with these presents.

Done at	•	, on			
	LOCATION		DATE		
Done at	LOCATION	_, on _	DATE	Xipeng ZHU	
Done at	LOCATION	_, on	DATE	Arvind SWAMINATHAN	
Done at	LOCATION	_, on	DATE	Jun WANG	***************************************
Done at	San Dieg			Genrae CHERIAN	

PATENT REEL: 035602 FRAME: 0980

**RECORDED: 05/06/2015**